TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

TPCF8101

Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: RDS (ON) = 22 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 14 \text{ S (typ.)}$
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -12 V)$
- Enhancement-model: $V_{th} = -0.5$ to -1.2 V

 $(V_{DS} = -10 \text{ V}, I_{D} = -200 \text{ }\mu\text{A})$

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-12	V	
Drain-gate voltage (R	GS = 20 kΩ)	V_{DGR}	-12	V	
Gate-source voltage		V _{GSS}	±8	V	
Drain current	DC (Note 1)	I _D	-6	А	
Diain current	Pulsed (Note 1)	I _{DP}	-24		
Drain power dissipation	on (t = 5 s) (Note 2a)	P_{D}	2.5	W	
Drain power dissipation	on (t = 5 s) (Note 2b)	P_{D}	0.7	W	
Single pulse avalanch	ne energy (Note 3)	E _{AS}	6.3	mJ	
Avalanche current		I _{AR}	-3	Α	
Repetitive avalanche	energy (Note 4)	E _{AR}	0.25	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	-55~150	°C	

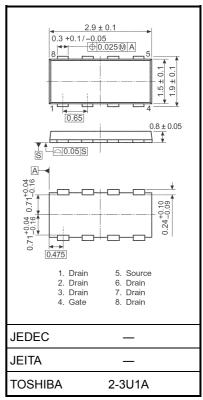
Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R _{th (ch-a)}	50.0	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.6	°C/W

Note: For (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5), please refer to the next page.

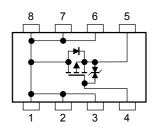
This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

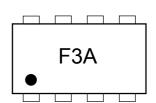


Weight: 0.011 g (typ.)

Circuit Configuration



Marking (Note 5)



Electrical Characteristics (Ta = 25°C)

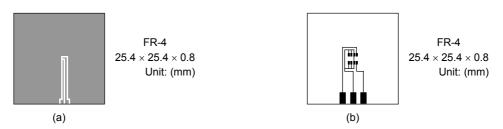
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I _{GSS}	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ	
Drain cut-off curr	n cut-off current		$V_{DS} = -12 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-10	μА	
Drain-source breakdown voltage		V _{(BR)DSS}	$I_D = -10$ mA, $V_{GS} = 0$ V	-12	_	_	V	
		V _{(BR)DSX}	$I_D = -10$ mA, $V_{GS} = 8$ V	-4	_	_		
Gate threshold ve	oltage	V _{th}	$V_{DS} = -10 \text{ V}, I_D = -200 \mu\text{A}$	-0.5	_	-1.2	V	
Drain-source ON resistance		R _{DS} (ON)	$V_{GS} = -1.8 \text{ V}, I_D = -1.5 \text{ A}$	_	60	85		
		R _{DS} (ON)	$V_{GS} = -2.5 \text{ V}, I_D = -3.0 \text{ A}$	_	32	40	$m\Omega$	
		R _{DS} (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -3.0 \text{ A}$	_	22	28		
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -3.0 \text{ A}$	7	14	_	S	
Input capacitance		C _{iss}		_	1600	_	pF	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	260	_		
Output capacitance		C _{oss}		_	335	_		
Switching time	Rise time	t _r	0 V 7 Γ I _D = -3.0 A	_	7	_		
	Turn-on time	t _{on}	$V_{GS} = 0 \text{ A}$ $V_{GS} = 0 $	_	13	_		
	Fall time	t _f	27.7 W W W W W W W W W W W W W W W W W W	_	21	_	ns	
	Turn-off time	t _{off}	$V_{DD} \simeq -6 \text{ V}$ Duty \leq 1%, $t_W = 10 \mu\text{s}$	_	68	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -10 \text{ V}, V_{GS} = -5 \text{ V},$		18.0	_		
Gate-source charge		Q _{gs}	$I_D = -6.0 \text{ A}$	_	14.5	_	nC	
Gate-drain ("miller") charge		Q _{gd}		_	3.5	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics Symbol		Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	-24	Α
Forward voltage	(diode)	V _{DSF}	$I_{DR} = -6.0 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	1.2	V

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)

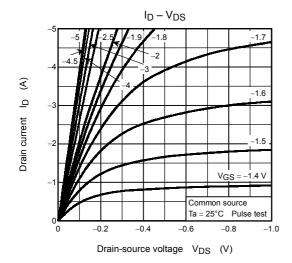


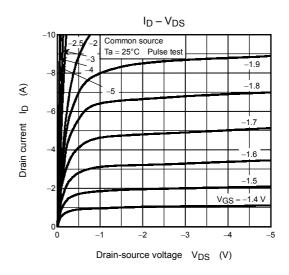
Note 3: V_{DD} = -10 V, T_{Ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = -3.0 A

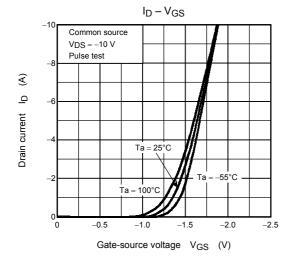
Note 4: Repetitive rating: pulse width limited by Max. Channel temperature.

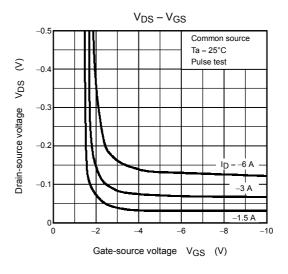
Note 5: Black round marking "●" locates on the left lower side of parts number "F3A" indicates terminal No.1.

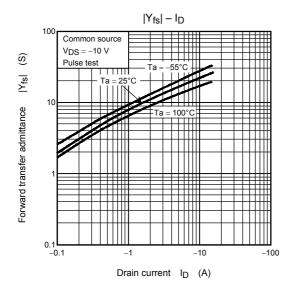
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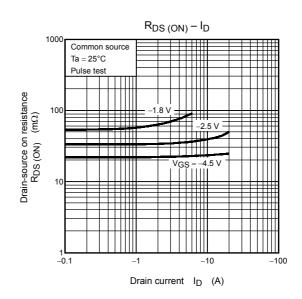




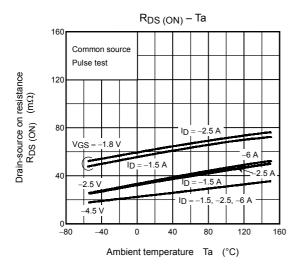


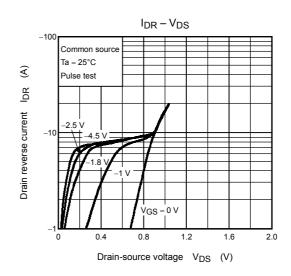


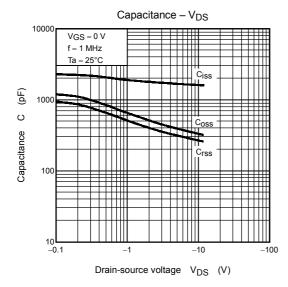


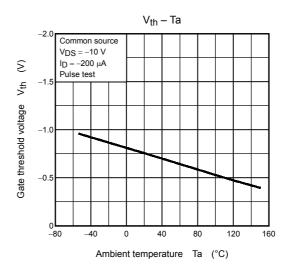


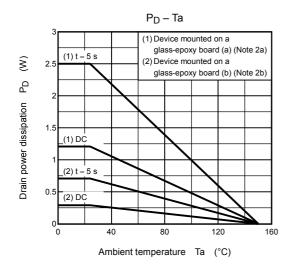
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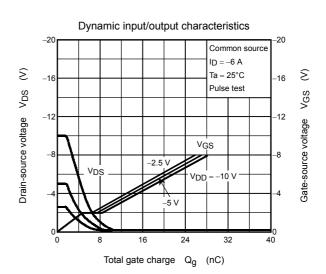


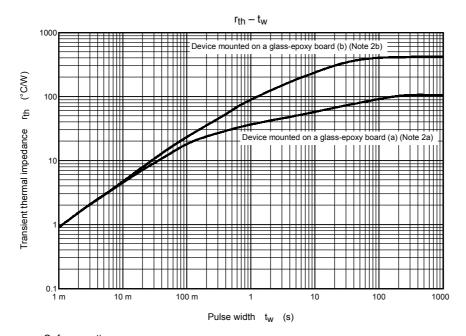


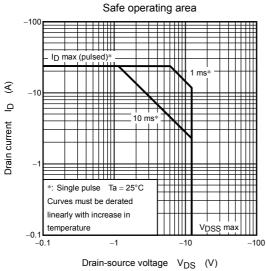












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